

# TECHNICAL SPECIFICATION



**Nanomanufacturing – Key control characteristics –  
Part 6-10: Graphene-based material – Sheet resistance: Terahertz time-domain  
spectroscopy**



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Part 6-10: Graphene-based material – Sheet resistance: Terahertz time-domain  
spectroscopy**

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**NANOMANUFACTURING – KEY CONTROL CHARACTERISTICS –****Part 6-10: Graphene-based material – Sheet resistance:  
Terahertz time-domain spectroscopy**

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The text of this Technical Specification is based on the following documents:

Draft	Report on voting
113/568/DTS	113/604/RVDTS

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Specification is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

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## INTRODUCTION

Graphene is an important nanomaterial in R&D and industry due to its outstanding electrical properties. It is already present in multiple commercial products, and furthermore, it is a strong candidate as an electrical material in numerous new application areas. However, no established method to characterize its local electrical performance and quality across large areas exists yet. The four-point probe method, either as single point or mapping (scanning) technique, is an industry standard for silicon wafers and conventional thin films, but unavoidably leads to damage, due to the physical contact between the tip and the one atom thin graphene film. The microwave resonant cavity method has been demonstrated as a mapping technique for graphene, but with spatial and sample resolution limited by the cavity size: no attempt has been made to scale this technique to industrially relevant sample sizes. Other methods for providing spatial information relating in some way to electrical quality include optical, Raman and scanning electron microscopies. These ones give local information that only indirectly relates to the electrical properties of interest.

The focus of this document is to provide a method to characterize the electrical performance, quality and uniformity of large-area graphene films with terahertz time-domain spectroscopy (THz-TDS). THz-TDS allows for large-area mapping of graphene films in a non-destructive, fast and robust mode, without contact and with no sample preparation at all. This method has no upper limitations in the size of the graphene film to be analysed. It is applicable for statistical process control, comparison of graphene films produced by different vendors, obtaining information about imperfections on the microscale such as grain boundaries and defects, and uniquely allows process modifications and development to be analysed step by step due to its non-destructive property and ability to access buried conductive layers. THz-TDS has been tested against other methods such as van der Pauw (vdP), electrical resistance tomography and calibrated Kelvin probe force microscopy with good matching of results [1] [2]<sup>1</sup>.

THz-TDS method provides direct measurements of the sheet resistance, both in transmission and reflection modes [3]. The spatial resolution is related with the diffraction limited THz beam spot size, reaching about 300 µm at 1 THz, and the maximum surface density of measurements is determined by the minimum step-size of the actuator moving the sensor or the sample.

The default sample in this document is monolayer graphene grown by chemical vapour deposition (CVD) on or transferred to a quartz substrate. Nevertheless, the methodology can be extended to graphene on silicon carbide (epitaxial graphene), multilayer graphene, and thin conductors generally, including other 2D materials, on several other dielectric and high resistive substrates including sapphire, silicon coated with silicon dioxide, silicon carbide, polymers and III-V semiconductors, among others. It is noted that for the reflection-mode THz-TDS, the technique tolerates less THz-transparent substrates (e.g. medium to highly doped silicon) than the transmission-mode THz-TDS.

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<sup>1</sup> Numbers in square brackets refer to the Bibliography.

## NANOMANUFACTURING – KEY CONTROL CHARACTERISTICS –

### Part 6-10: Graphene-based material – Sheet resistance: Terahertz time-domain spectroscopy

#### 1 Scope

This part of IEC TS 62607 establishes a standardized method to determine the electrical key control characteristic

- sheet resistance ( $R_s$ )

for films of graphene-based materials by

- terahertz time-domain spectroscopy (THz-TDS).

In this technique, a THz pulse is sent to the graphene-based material. The transmitted or reflected THz waveform is measured in the time domain and transformed to the frequency domain by the fast Fourier transform (FFT). Finally, the spectrum is fitted to the Drude model (or another comparable model) to obtain the sheet resistance.

- This non-contact inspection method is non-destructive, fast and robust for the mapping of large areas of graphene films, with no upper sample size limit.
- The method is applicable for statistical process control, comparison of graphene films produced by different vendors, or to obtain information about imperfections on the microscale such as grain boundaries and defects, etc.
- The method is applicable for graphene grown by chemical vapour deposition (CVD) or other methods on or transferred to dielectric substrates, including but not limited to quartz, silica ( $\text{SiO}_2$ ), silicon (Si), sapphire, silicon carbide (SiC) and polymers.
- The minimum spatial resolution is in the order of 300  $\mu\text{m}$  (at 1 THz) given by the diffraction limited spot size of the THz pulse.

#### 2 Normative references

There are no normative references in this document.

#### 3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: [available at http://www.iso.org/obp](http://www.iso.org/obp)

##### 3.1 General terms

###### 3.1.1

**graphene**

**graphene layer**

**single-layer graphene**

**monolayer graphene**

**1LG**

single layer of carbon atoms with each atom bound to three neighbours in a honeycomb structure